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PATENT
Case No. 421 P.039

FICE

JAN 06 2004

TC 1700

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Richard Barcock et al.

Serial No 10/055,073

Filed: January 23, 2002

For: POROUS INK JET RECORDING

MATERIAL

Examiner: B. Shewareged

Group Art Unit: 1774

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to:

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DECEMBER 29,2003

(Date of Deposit)

Elaunda Banks

Name of applicant assignee, or Registered Rep.

Ndu 70allV Signature

Date⁴

REPLY TO FIRST OFFICE ACTION

Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450

Sir:

In reply to the first Official Office action (Paper No. 5), mailed October 7, 2003, please amend the above-captioned application as follows:

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December 29, 2003

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> P.O. Box 33 02 29 D-40435, Düsseldorf **GERMANY**

> > Re:

U.S. Patent Application

Barcock et al.

"POROUS INK JET RECORDING MATERIAL"

Your Reference No. MI/ho 080/266US

Our Reference No. 421 P 039

Dear Ralph:

As requested by your letter to us of 22 December 2003, we have prepared and today filed a Reply to First Office Action, a copy of which is enclosed.

We will keep you advised of further developments in the application.

Very truly yours

Daniel M. Riess

DMR/eab Enclosure